3.0x2.5mm SURFACE MOUNT LED LAMP

Part Number: APBL3025SURKCGK-F01

Hyper Red Green

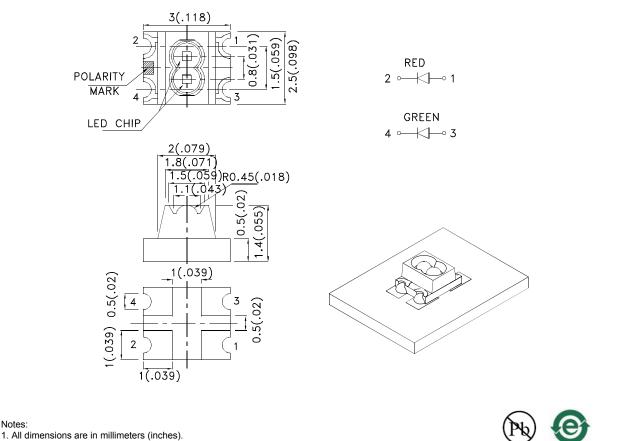
Features

- 3.0mmx2.5mm SMT LED, 1.4mm thickness.
- Low power consumption.
- Wide viewing angle.
- Ideal for back light and indicator.
- Various colors and lens types available.
- Inner lens type.
- Moisture sensitivity level : level 3.
- Package : 2000pcs / reel.
- RoHS compliant.

Description

The Hyper Red source color devices are made with Al-GaInP on GaAs substrate Light Emitting Diode. The Green source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode.

Package Dimensions



2. Tolerance is ±0.2(0.008") unless otherwise noted.

The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
The device has a single mounting surface. The device must be mounted according to the specifications.

SPEC NO: DSAF1335 **APPROVED: WYNEC**

Notes:

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Selection Guide lv (mcd) [2] Viewing @ 20mA Angle [1] Part No. Dice Lens Type 201/2 Min. Тур. 400 600 Hyper Red (AlGaInP) *80 *200 APBL3025SURKCGK-F01 Water Clear 100° 55 120 Green (AlGaInP) *55 *120

Notes:

1. θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.

Luminous intensity/ luminous Flux: +/-15%.
* Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Hyper Red Green	645 574		nm	I⊧=20mA
λD [1]	Dominant Wavelength	Hyper Red Green	630 570		nm	I⊧=20mA
Δλ1/2	Spectral Line Half-width	Hyper Red Green	28 20		nm	I⊧=20mA
С	Capacitance	Hyper Red Green	35 15		pF	VF=0V;f=1MHz
Vf [2]	Forward Voltage	Hyper Red Green	1.95 2.1	2.5 2.5	V	I⊧=20mA
lr	Reverse Current	Hyper Red Green		10 10	uA	VR = 5V

Notes:

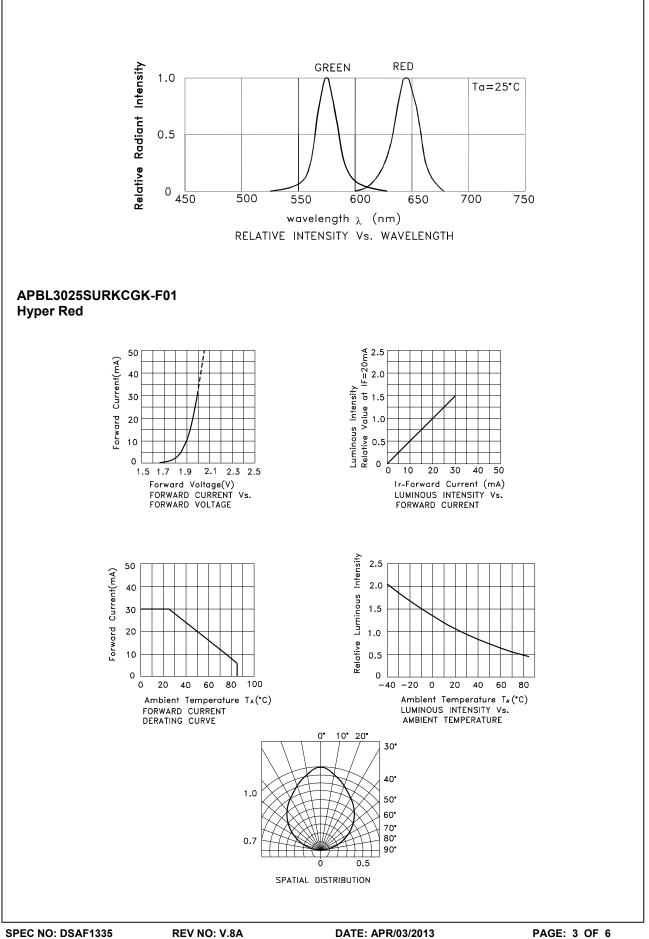
1.Wavelength: +/-1nm.

Forward Voltage: +/-0.1V.
Wavelength value is traceable to the CIE127-2007 compliant national standards.

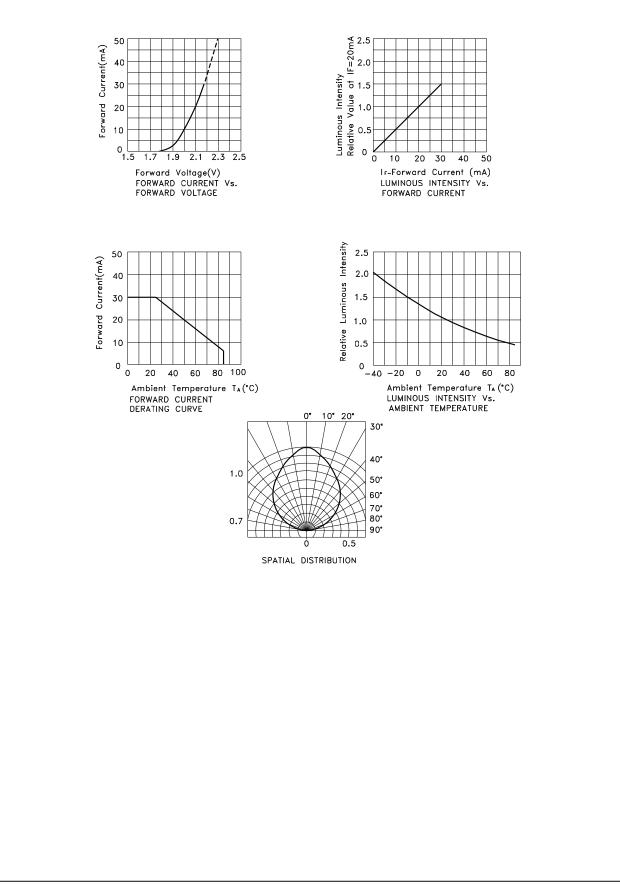
Absolute Maximum Ratings at TA=25°C

Parameter	Hyper Red	Green	Units		
Power dissipation	75	75	mW		
DC Forward Current	30	30	mA		
Peak Forward Current [1]	185	150	mA		
Reverse Voltage		V			
Operating Temperature	-40°C To +85°C				
Storage Temperature	-40°C To +85°C				

Note: 1. 1/10 Duty Cycle, 0.1ms Pulse Width.



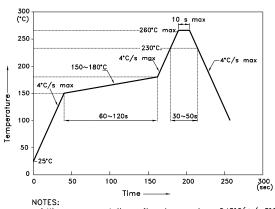
Green



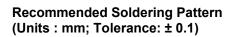
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Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

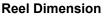
Reflow Soldering Profile For Lead-free SMT Process.

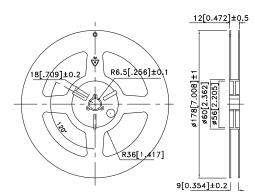


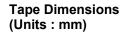
NOTES: 1.We recommend the reflow temperature 245°C(+/-5°C).The maximum soldering temperature should be limited to 260°C. 2.Don't cause stress to the epoxy resin while it is exposed to high temperature. 3.Number of reflow process shall be 2 times or less.

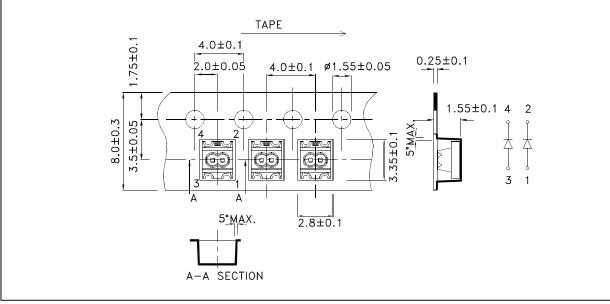


4.4 0.6 L- 1.0





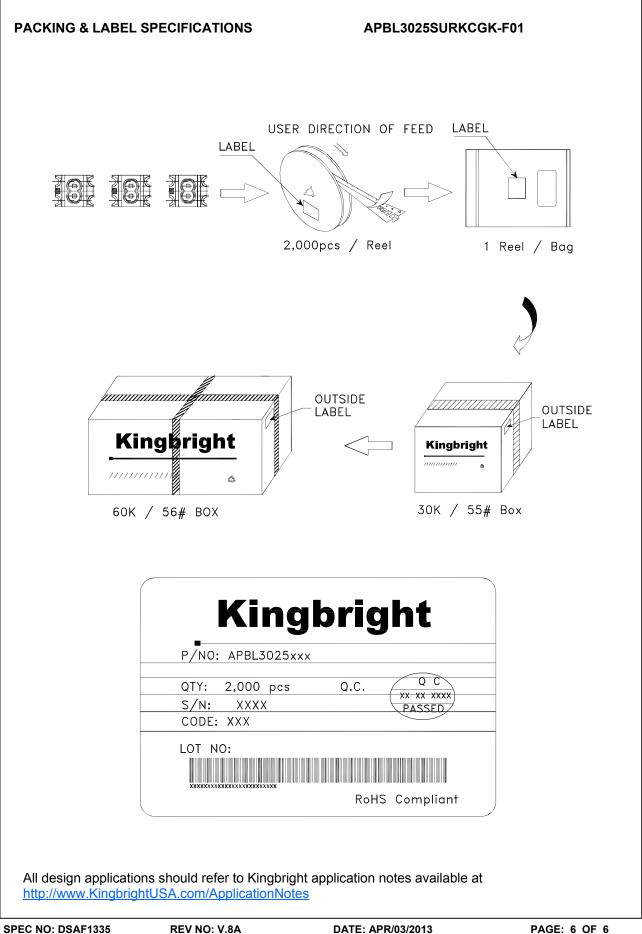




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